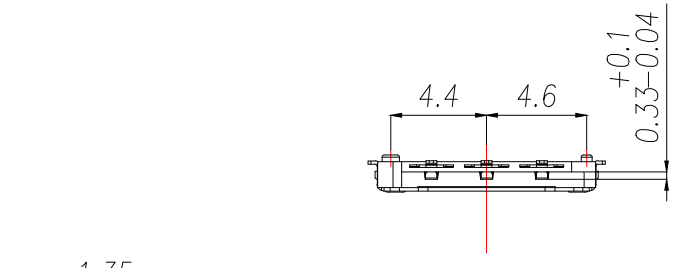
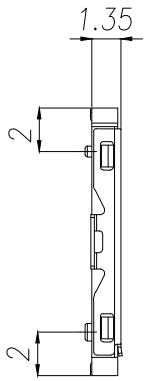
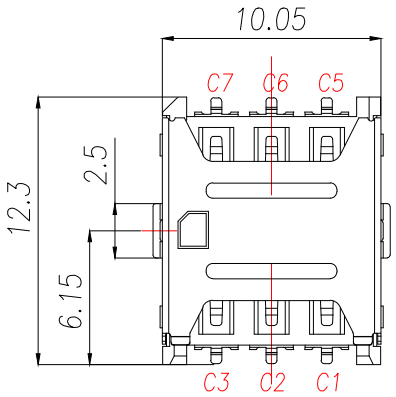
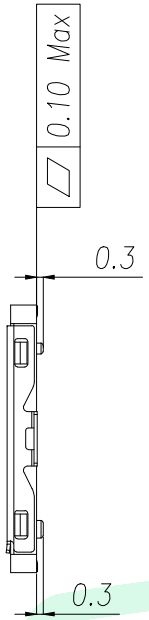
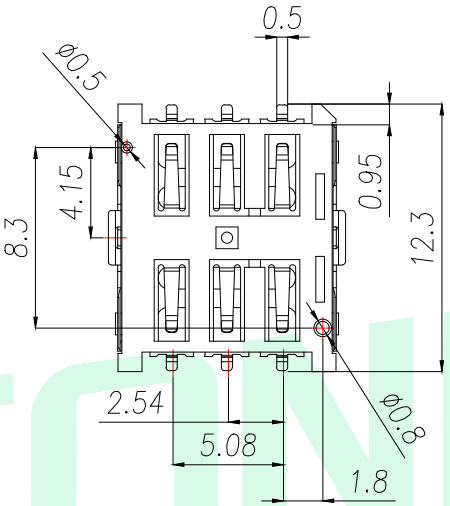
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|---|---|---|---|---|
| | | | | |

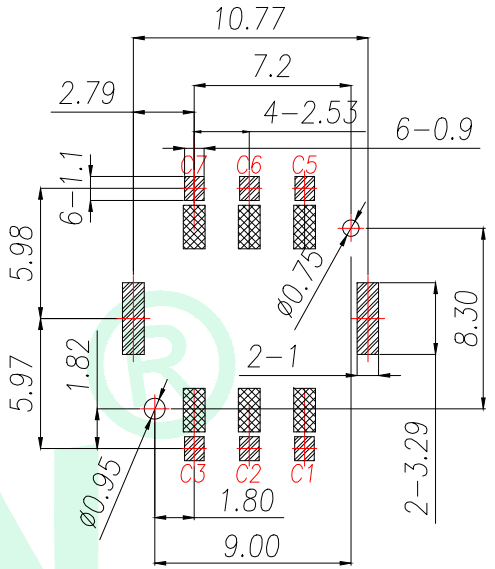


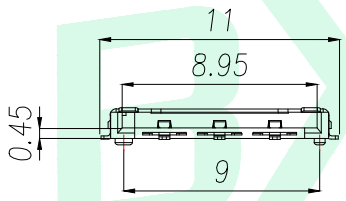



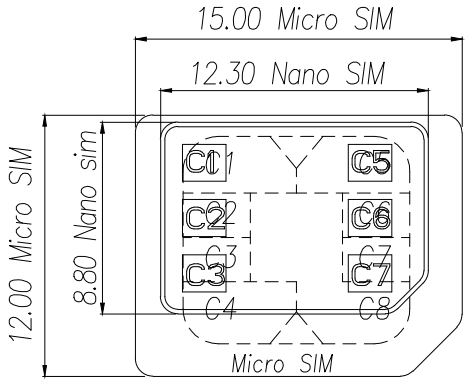




RECOMMENDED PCB LAYOUT

PATTERN PROHIBITION AREA




| SIM pin assignment | |
|---|---|
| PIN# | Name |
| C1 | VCC供电电压 |
| C2 | RST重置 |
| C3 | CLK时钟 |
| C5 | GND接地 |
| C6 | VPP程序电压 |
| C7 | I/O输入输出 |

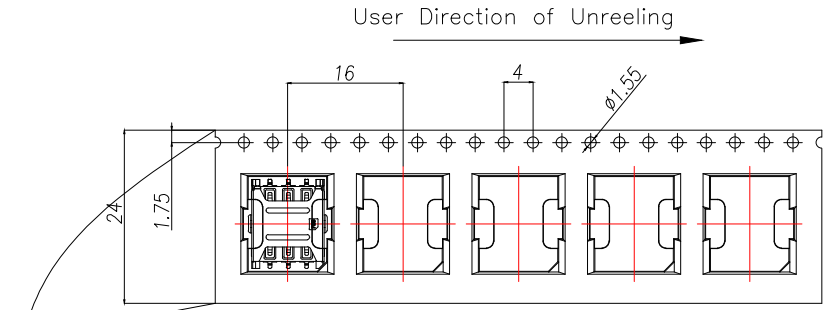



NOTES:
1. MATERIAL:
1−1.Insulator: High Temperature Thermoplastic, UL94V−0; Color Black.
1−2.Terminal: Copper Alloy.
1−3.Shell: Stainless Steel.
2. PLATING:
2−1.Contact: Plated 50u" Ni Overall Contact Au 1u",
2−2.Shell: Plated 50u" Ni Overall,PAD Au 1u"
3. SPECIALITY:
3−1.Current Rating :0.5mA AC/DC max.
3−2.Voltage Rating :125V AC/DC
3−3.Ambient Temperature Range :−20°C~+60°C
3−4.Storage Temperature Range :−40°C~+70°C
3−5.Ambient Humidity Range :95% R.H. Max.
3−6.Contact Resistance:100mΩ max.
3−7.Insulation Resistance:1000MΩ min./500VDC
3−8.Mating Cycles:10,000 Insertions
3−9.Reflow peak temp.:260°C ±5°C, 3~5 S
3−10.Mating Cycles:3,000 Insertions Min

| GENERAL TOLERANCE | | | | | DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD | | | | BXCONN® |
|---|---|---|---|---|---|---|---|---|---|
| DIM. | TOL. | | | | TITLE: NANO−SIM 卡座 6pin 1.35H 有柱 抽拉式 | | | | |
| x. | ±0.30 | | | | | | | | |
| x.x | ±0.20 | | | | DWG. NO.: NANOSIM−6P−H135 | | | CHECKED: MAX | |
| x.xx | ±0.10 | | | | | | | | |
| GENERAL ANGLE: | | | | | PART NO.: NANOSIM−6P−H135 | | | DRAWN: ELLA | |
| X.° | ±3° | | | | | | | | |
| X.X° | ±2° | | | | UNIT: mm | SCALE: none | SHEET: 1of 1 | DWG. SIZE: A4 | LAYER: bxconn | APPROVED: WILL |
| X.XX° | | | | | | | | | |

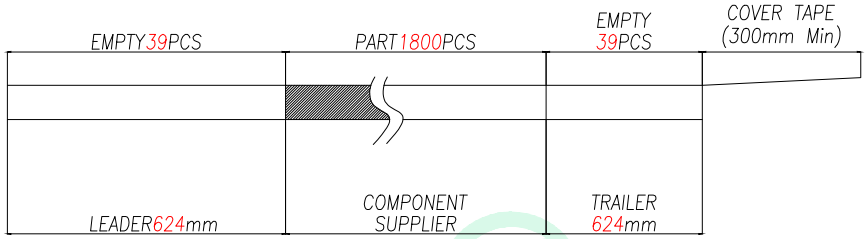
BXCONN®

| REV. | DESCRIPTION | ECN NO. | NAME | DATE |
|---|---|---|---|---|
| | | | | |




NOTES

1. NUMBER OF CONNECTORS:1800PCS/REEL
2. LEAD TAPE LENGTH

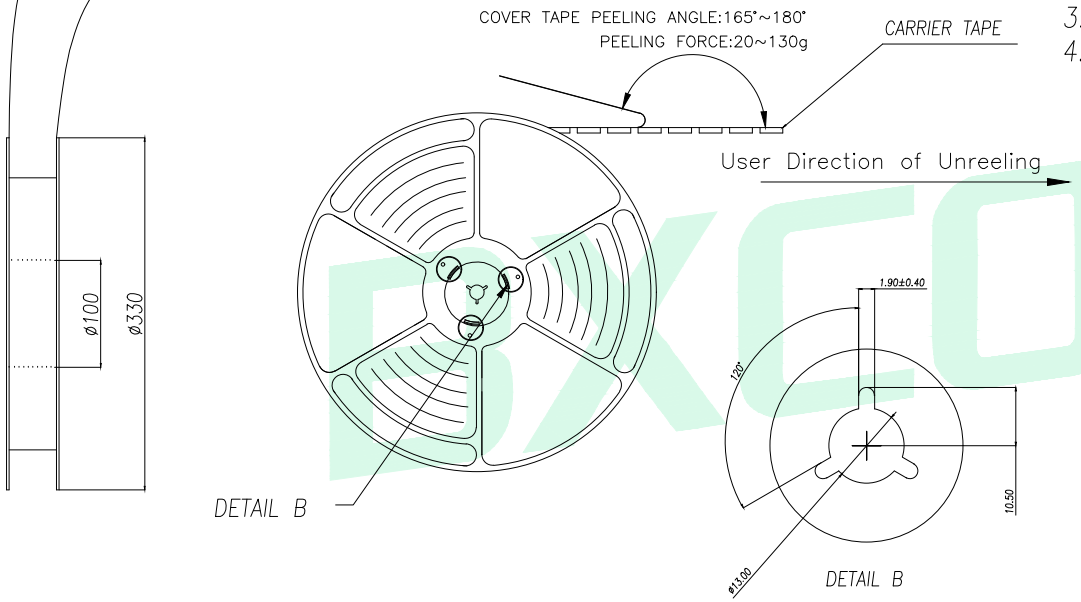


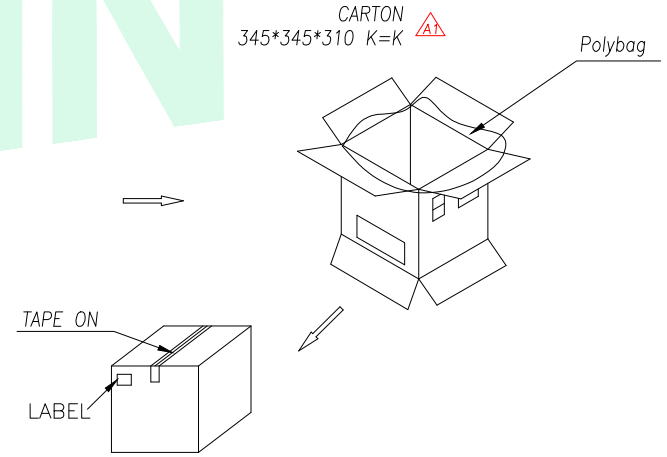

3.QUANTITY:18000PCS/CARTON

4. WEIGHT :

3.1 NET WEIGHT : Kg

3.2 GROSS WEIGHT : Kg




| GENERAL TOLERANCE | DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD | BXCONN® |
|---|---|---|
| DIM. TOL.<br>x. ±0.30<br>x.x ±0.20<br>x.xx ±0.10<br>GENERAL ANGLE:<br>x° ±3°<br>x.x° ±2°<br>x.xx° | TITLE: NANO-SIM 卡座 6pin 1.35H 有柱 | |
| | DWG. NO.: NANOSIM-6P-H135 | CHECKED: MAX |
| | PART NO.: NANOSIM-6P-H135 | DRAWN: ELLA |
| | UNIT: mm / SCALE: none / SHEET: 1of 1 / DWG. SIZE: A4 / LAYER: bxconn | APPROVED: WILL |